

Product Summary (@ T_A = +25 °C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V)	I _{R(MAX)} (mA)
30	3	0.49	0.02

Description and Applications

Packaged in the compact U-DFN3030-8 package, the TrenchSBR SBRT3M30LP provides excellent low reverse leakage stability at high temperatures. It is ideal for use in low voltage, high frequency inverters, as well as freewheeling and polarity protection applications.

- AC-DC Adaptors/Chargers
- DC-DC Converters
- Bypass Diode
- Boost Diode
- Blocking Diode
- Recirculating Diode

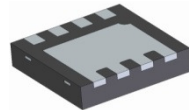
Features and Benefits

- Low Power Loss, High Efficiency
- Low Reverse Leakage Current
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

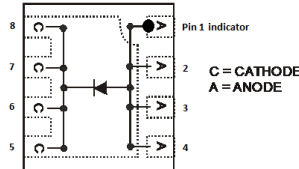
Mechanical Data

- Case: U-DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 **64**
- Polarity: See Diagram
- Weight: 0.0172 grams (Approximate)

U-DFN3030-8



Bottom View


 Top View
Schematic and Pin Configuration

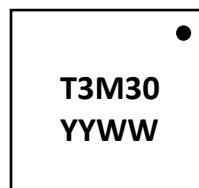
Ordering Information (Note 4)

Part Number	Qualification	Case	Packaging
SBRT3M30LP-7	Commercial	U-DFN3030-8	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

U-DFN3030-8



T3M30 = Product Marking Code
 YYWW = Date Code Marking
 YY = Last Digit of Year (ex: 15 for 2015)
 WW = Week Code (01 ~ 53)

Maximum Ratings (@T_A = +25 °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Rectified Output Current	I _O	3.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	30	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	15	°C/W
Typical Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	152	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	7	°C/W
Typical Thermal Resistance Junction to Ambient Air (Note 6)	R _{θJA}	76	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	30	—	—	V	I _R = 0.02mA
Forward Voltage	V _F	—	0.45 0.43	0.49 —	V	I _F = 3.0A, T _a = +25 °C I _F = 3.0A, T _a = +125 °C
Reverse Current (Note 7)	I _R	—	0.005	0.02	mA	T _J = +25 °C, V _R = 30V
Total Capacitance	C _T	—	100	—	pF	f = 1MHz, V _R = 30V
Reverse Recovery Time	t _{rr}	—	16	—	ns	I _F = 0.5A, I _R = 1.0A, I _{RR} = 0.25A

Notes: 5. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com>. T_A = +25 °C.
6. PCB with 1-inch sq. Copper pad, 2oz.
7. Short duration pulse test used to minimize self-heating effect.

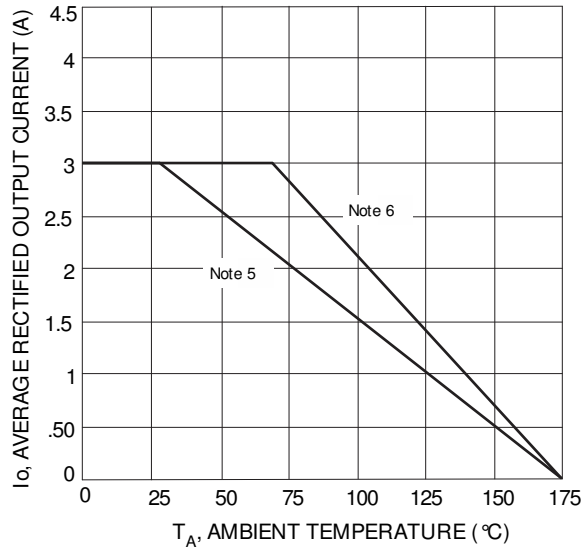


Figure 1, DC Forward Current Derating

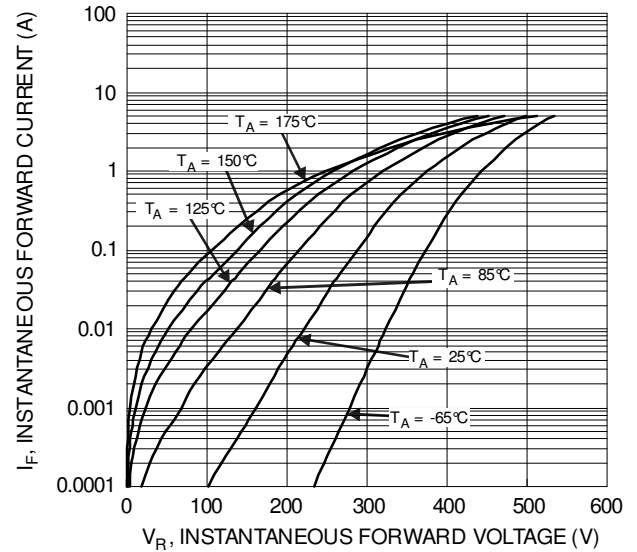


Figure 2 Typical Forward Characteristics

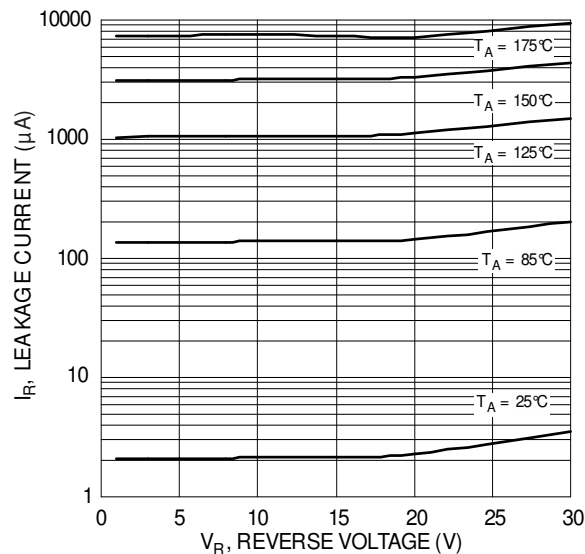


Figure 3 Typical Reverse Characteristics

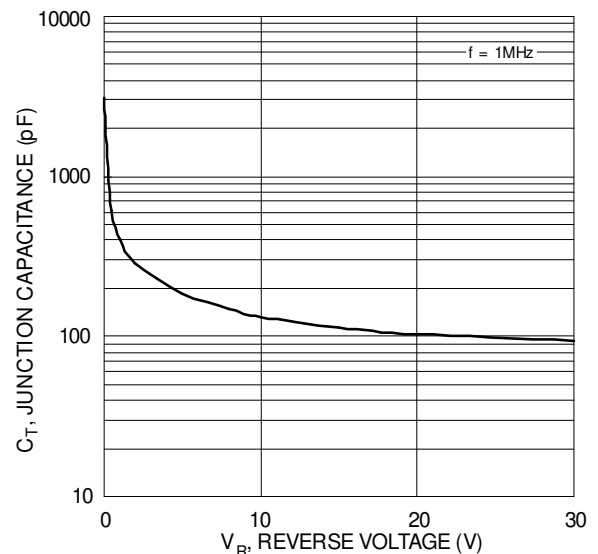


Figure 4 Typical Junction Capacitance

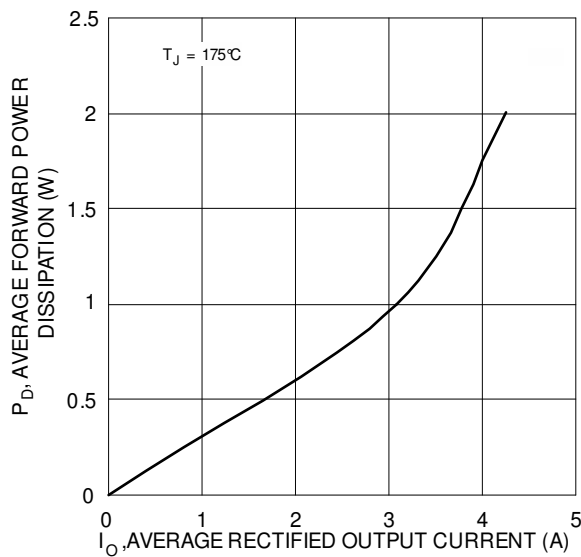


Figure 5 Forward Power Dissipation

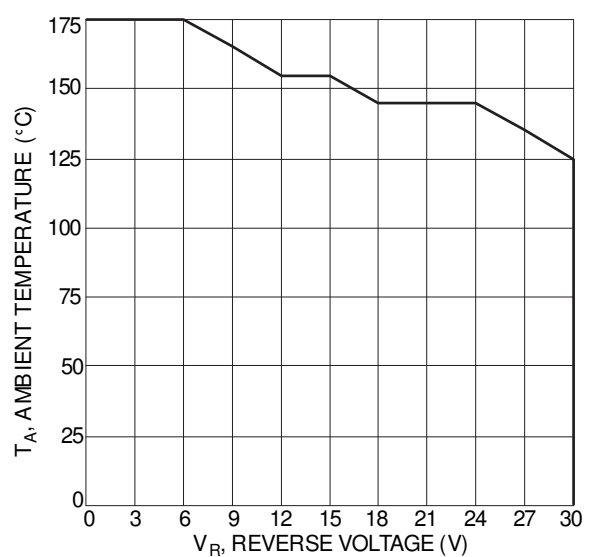
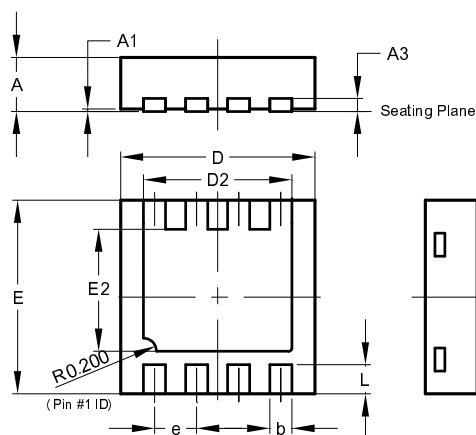


Figure 6 Reverse Voltage Derating

Package Outline Dimensions

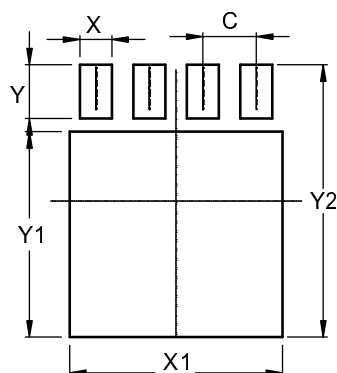
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



U-DFN3030-8			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0	0.05	0.02
A3	-	-	0.15
b	0.29	0.39	0.34
D	2.90	3.10	3.00
D2	2.19	2.39	2.29
e	-	-	0.65
E	2.90	3.10	3.00
E2	1.64	1.84	1.74
L	0.30	0.60	0.45
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	0.650
X	0.390
X1	2.590
Y	0.650
Y1	2.490
Y3	3.300

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Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.